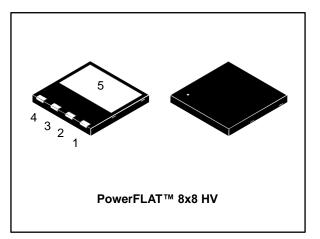


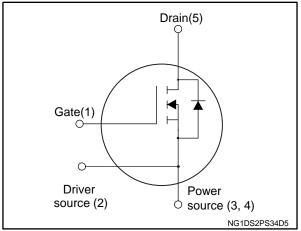
# STL57N65M5

### N-channel 650 V, 0.061 Ω typ., 22.5 A MDmesh<sup>™</sup> M5 Power MOSFET in a PowerFLAT<sup>™</sup> 8x8 HV package

Datasheet - production data



#### Figure 1: Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub> @ T <sub>Jmax</sub>	R <sub>DS(on)</sub> max.	ID
STL57N65M5	710 V	0.069Ω	22.5 A

- Extremely low R<sub>DS(on)</sub>
- Low gate charge and input capacitance
- Excellent switching performance
- 100% avalanche tested

#### **Applications**

• Switching applications

### Description

This device is an N-channel Power MOSFET based on the MDmesh<sup>™</sup> M5 innovative vertical process technology combined with the wellknown PowerMESH<sup>™</sup> horizontal layout. The resulting product offers extremely low onresistance, making it particularly suitable for applications requiring high power and superior efficiency.

#### Table 1: Device summary

Order code	Marking	Package	Packing
STL57N65M5	57N65M5	PowerFLAT™ 8x8 HV	Tape and reel

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This is information on a product in full production.

#### Contents

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### 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	650	V
V <sub>GS</sub>	Gate-source voltage	± 25	V
ID <sup>(1)</sup>	Drain current (continuous) at $T_c = 25 \text{ °C}$	22.5	А
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	22	А
I <sub>DM</sub> <sup>(1)(2)</sup>	Drain current (pulsed)	90	А
I <sub>D</sub> <sup>(3)</sup>	Drain current (continuous) at $T_{pcb} = 25 \text{ °C}$ 4.3		А
I <sub>D</sub> <sup>(3)</sup>	Drain current (continuous) at $T_{pcb} = 100 \text{ °C}$ 2.7		А
P <sub>TOT</sub> <sup>(3)</sup>	Total dissipation at $T_{pcb} = 25 \text{ °C}$ 2.8		W
P <sub>TOT</sub> <sup>(1)</sup>	Total dissipation at $T_c = 25 \text{ °C}$ 189		W
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by Tj max)	9	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25 \text{ °C}$ , $I_D = I_{AR}$ , $V_{DD} = 50 \text{ V}$ )	960	mJ
dv/dt <sup>(4)</sup>	Peak diode recovery voltage slope 15		V/ns
T <sub>stg</sub>	Storage temperature	- 55 to 150	℃
Tj	Max. operating junction temperature	150	

#### Notes:

 $^{(1)}\mbox{The value is rated according to $R_{\mbox{thj-case rated}}$ and limited by package.}$ 

<sup>(2)</sup>Pulse width limited by safe operating area.

 $^{(3)}\mbox{When}$  mounted on FR-4 board of 1  $\mbox{inch}^2$  , 2oz Cu.

 $^{(4)}I_{SD}$   $\leq$  22.5 A, di/dt  $\leq$  400 A/µs; V\_DS(peak) < V(BR)DSS, V\_DD = 400 V.

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.66	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb max		°C/W

#### Notes:

 $^{(1)}\mbox{When}$  mounted on FR-4 board of 1 inch², 2oz Cu.



### 2 Electrical characteristics

 $T_C = 25$  °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA	650			V
	Zoro goto voltago Droin	$V_{GS} = 0 V, V_{DS} = 650 V$			1	μA
I <sub>DSS</sub>	Zero gate voltage Drain current	$V_{GS} = 0 V, V_{DS} = 650 V,$ $T_{C}= 125 \text{ °C}$			100	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 17.5 \text{ A}$		0.061	0.069	Ω

Table 5: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	4200	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz, V <sub>GS</sub> = 0 V	-	100	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	6	-	pF
C <sub>o(er)</sub> <sup>(1)</sup>	Equivalent output capacitance energy related			97	-	pF
C <sub>o(tr)</sub> <sup>(2)</sup>	Equivalent output capacitance time related	V <sub>(BR)DSS</sub>	-	344	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	1.4	-	Ω
Qg	Total gate charge	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 17.5 \text{ A},$	-	96	-	nC
$Q_{gs}$	Gate-source charge V <sub>GS</sub> = 10 V		-	24	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 15: "Gate charge test circuit")	-	40	-	nC

#### Notes:

 $^{(1)}C_{o(er)}$  is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

 $^{(2)}C_{o(tr)}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 



#### Electrical characteristics

Table 6: Switching times						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(V)</sub>	Voltage delay time	$V_{DD}$ = 400 V, $I_D$ = 22.5 A R <sub>G</sub> = 4.7 Ω, $V_{GS}$ = 10 V (see Figure 16: " Test circuit for inductive load switching and diode recovery times"and Figure 19: "Switching time waveform")		84	-	ns
t <sub>r(V)</sub>	Voltage rise time			10.8	-	ns
t <sub>f(i)</sub>	Crossing fall time			11	-	ns
t <sub>C(off)</sub>	Crossing time	,	-	16.5	-	ns

#### Table 7: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> <sup>(1)</sup>	Source-drain current		-		22.5	А
I <sub>SDM</sub> <sup>(1)</sup> , <sup>(2)</sup>	Source-drain current (pulsed)		-		90	A
V <sub>SD</sub> <sup>(3)</sup>	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 22.5 A$	-		1.5	V
t <sub>rr</sub>	Reverse recovery time		-	378		ns
Q <sub>rr</sub>	Reverse recovery charge	$I_{SD}$ = 22.5 A, di/dt = 100 A/µs, $V_{DD}$ = 100 V (see Figure 16: " Test circuit for inductive load switching and diode recovery times")		7		μC
I <sub>RRM</sub>	Reverse recovery current			37		A
t <sub>rr</sub>	Reverse recovery time		-	454		ns
Q <sub>rr</sub>	Reverse recovery charge	$I_{SD}$ = 22.5 A, di/dt = 100 A/µs, V <sub>DD</sub> = 100 V, T <sub>j</sub> = 150 °C (see <i>Figure 16: " Test circuit</i> for inductive load switching and diode	-	9.5		μC
I <sub>RRM</sub>	Reverse recovery current	recovery times")	-	42		A

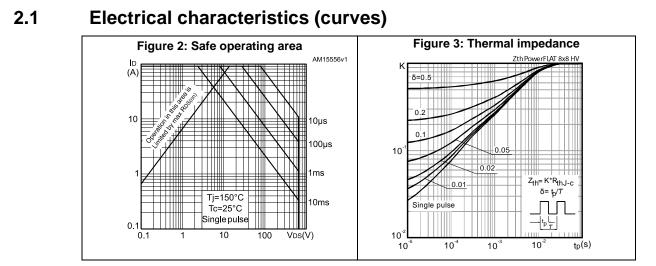
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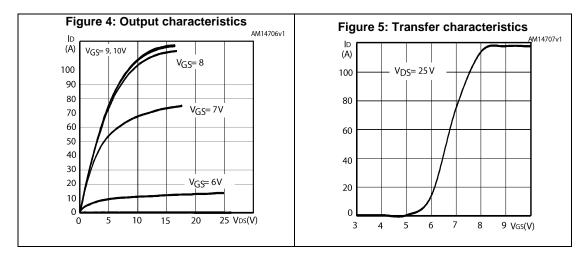
 $^{(1)}\ensuremath{\mathsf{The}}$  value is rated according to  $R_{thj\text{-case}}$  and limited by package.

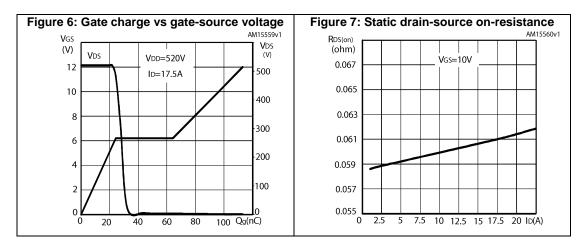
 $^{\rm (2)}{\rm Pulse}$  width is limited by safe operating area

 $^{(3)}\text{Pulsed:}$  pulse duration = 300  $\mu\text{s},$  duty cycle 1.5%

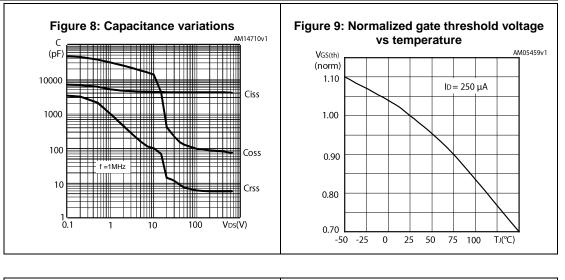


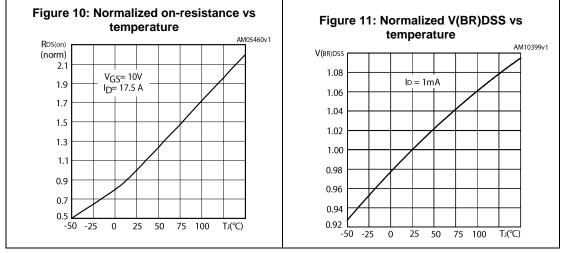


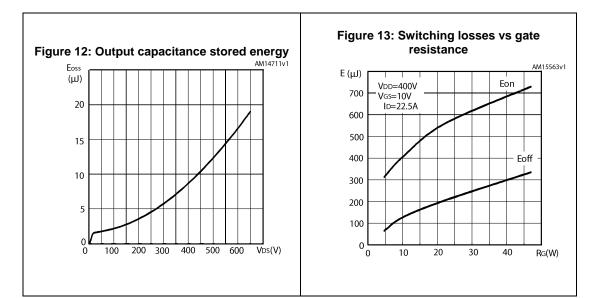










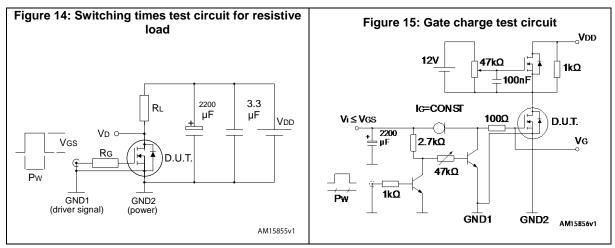


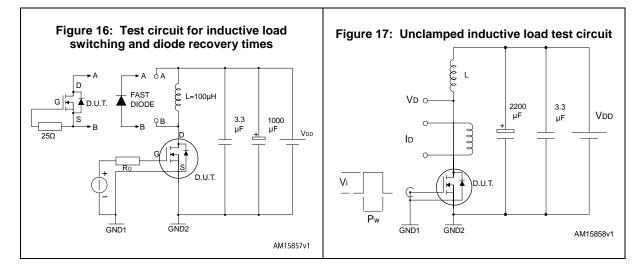
The previous figure  $E_{on}$  includes reverse recovery of a SiC diode.

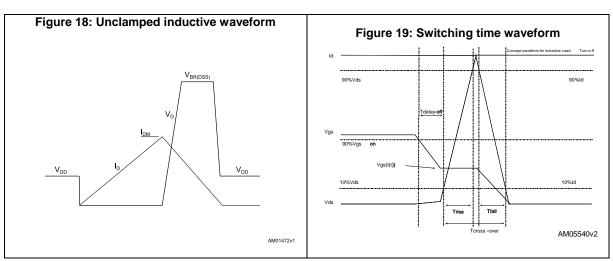


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### 3 Test circuits







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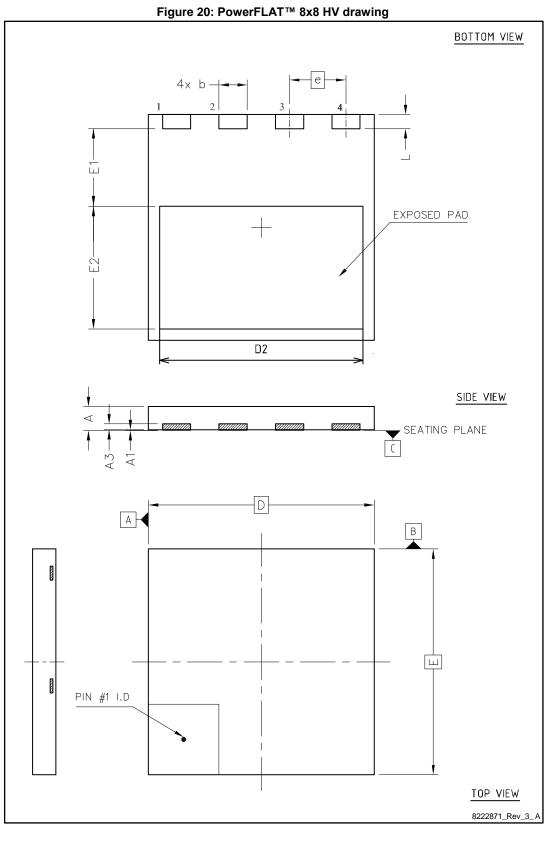
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### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



### 4.1 PowerFLAT<sup>™</sup> 8x8 HV package information





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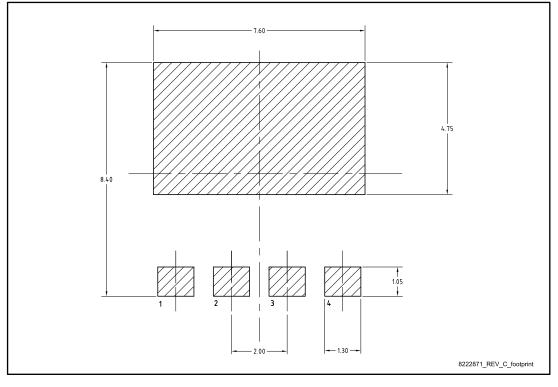
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#### Package information

#### STL57N65M5

Table 8: PowerFLAT™ 8x8 HV mechanical data						
Dim		mm				
Dim.	Min.	Тур.	Max.			
A	0.75	0.85	0.95			
A1	0.00		0.05			
A3	0.10	0.20	0.30			
b	0.90	1.00	1.10			
D	7.90	8.00	8.10			
E	7.90	8.00	8.10			
D2	7.10	7.20	7.30			
E1	2.65	2.75	2.85			
E2	4.25	4.35	4.45			
е		2.00				
L	0.40	0.50	0.60			

Figure 21: PowerFLAT™ 8x8 HV drawing





All dimensions are in millimeters.



#### 4.2

# PowerFLAT™ 8x8 HV packing information

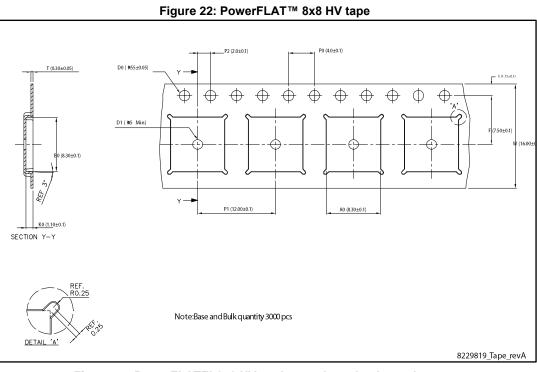
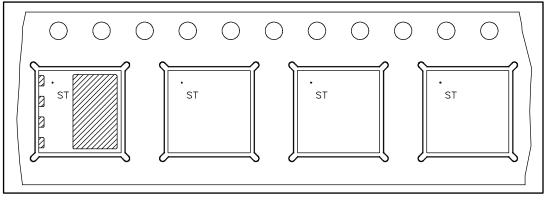
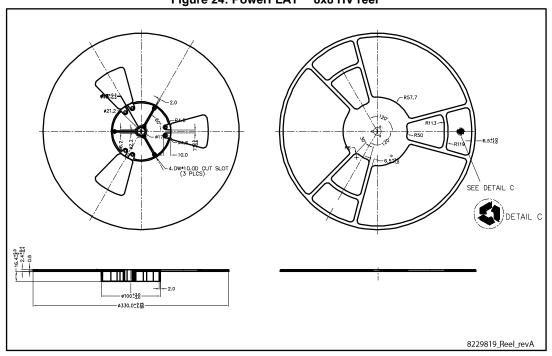


Figure 23: PowerFLAT™ 8x8 HV package orientation in carrier tape









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### 5 Revision history

Table 9: Document revision history

Date	Revisi on	Changes		
14-May-2012	1	First release.		
25-Jan-2013	2	<ul> <li>-Modified ID value and note 1 on first page</li> <li>-Modified: I<sub>D</sub>, P<sub>TOT</sub>, I<sub>AR</sub> values, and note1, 4 on Table 2</li> <li>-Modified: Rthj-case value on Table 3</li> <li>-Modified: R<sub>DS(on)</sub> on Table 4</li> <li>-Modified: typical values on Table 5 and 6</li> <li>-Modified: typical and max values on Table 7</li> <li>-Inserted: Section 2.1: Electrical characteristics (curves)</li> <li>-Document staus promoted from preliminary data to production data.</li> </ul>		
09-Oct-2015	3	Updated title, features and description Text and formatting changes throughout document. Updated Section 1: "Electrical ratings"and Section 2: "Electrical characteristics" Changes according to PCN9187: Updated package silhouette and figure Figure 1: "Internal schematic diagram" on cover page. Updated Section 4.1: "PowerFLAT™ 8x8 HV package information".		



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